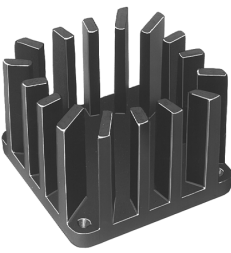
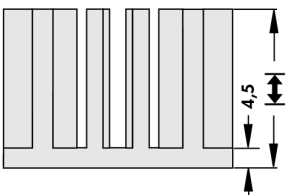
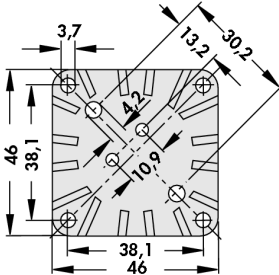
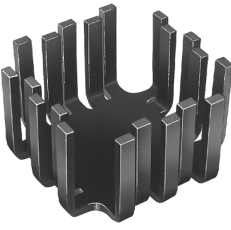
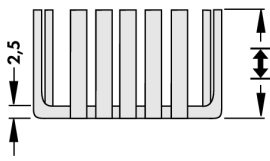
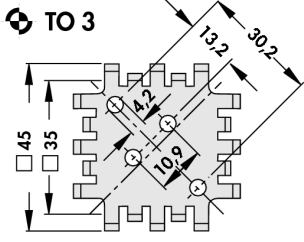
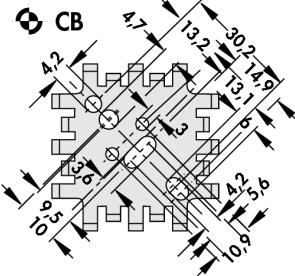
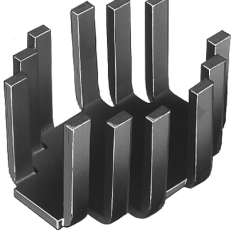
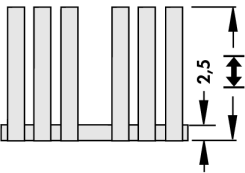
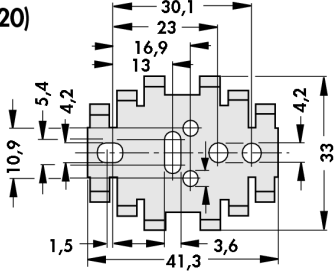


Finger shaped heatsinks for power semiconductors

							
art. no.	⊗	↕ [mm]	R _{th} [K/W]	art. no.	⊗	↕ [mm]	R _{th} [K/W]
FK 318 SA	without	31.8	4.8	FK 318 SA-3	TO 3	31.8	4.8
FK 254 SA	without	25.4	5.8	FK 254 SA-3	TO 3	25.4	5.8
FK 191 SA	without	19.1	6.6	FK 191 SA-3	TO 3	19.1	6.6
FK 127 SA	without	12.7	8.0	FK 127 SA-3	TO 3	12.7	8.0

material: die-cast aluminium
surface treatment: black lacquered

							
art. no.	⊗	↕ [mm]	R _{th} [K/W]	art. no.	⊗	↕ [mm]	R _{th} [K/W]
FK 201 SA	without	25.4	6	FK 202 SA	without	12.7	8
FK 201 SA 3	TO 3	25.4	6	FK 202 SA 3	TO 3	12.7	8
FK 201 SA CB	CB	25.4	6	FK 202 SA CB	CB	12.7	8

			
art. no.	⊗	↕ [mm]	R _{th} [K/W]
FK 205 SA L	L	31.8	9.0
FK 206 SA L	L	25.4	10.5
FK 207 SA L	L	19.1	12.0
FK 208 SA L	L	12.7	14.0

material: aluminium
surface treatment: black anodised

Attachable heatsinks
Heatsinks for TO 5 and TO 18
Heatsinks for D PAK
Aluminium oxide wafers

→ C 10 - 14
 → C 15 - 16
 → C 17
 → E 9 - 10

Snap rivet
Kapton insulator washers
Silicone wafers
Mica wafers

→ E 34
 → E 8
 → E 2 - 4
 → E 11